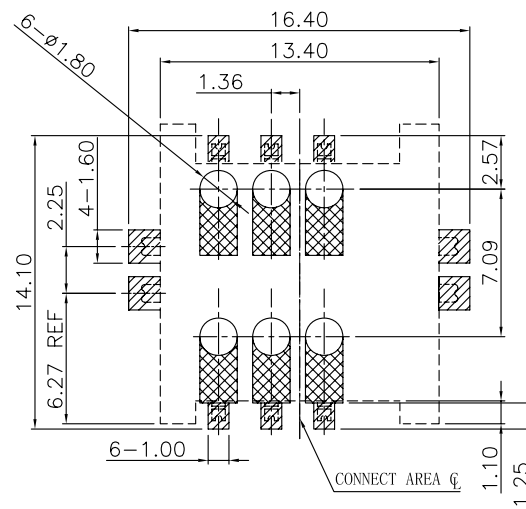
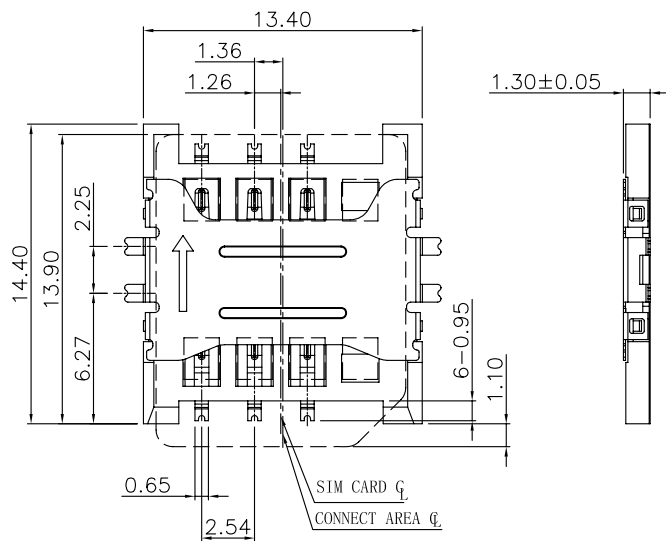



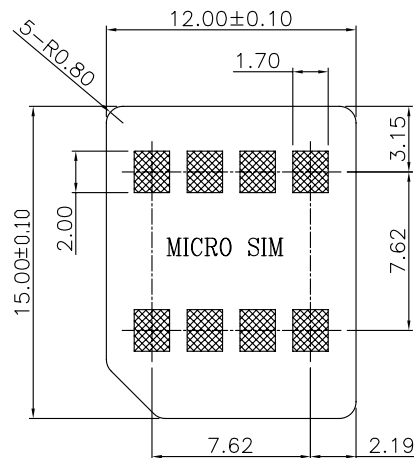
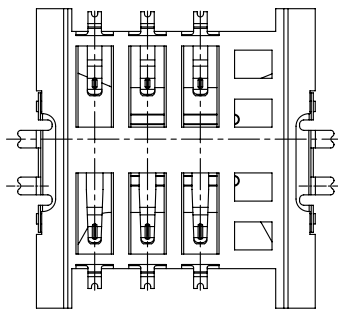
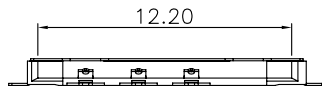


REV.	DESCRIPTION	DATE
A	RELEASE	SEP. 16, 2013
B	SPEC. MODIFY	OCT. 07, 2014



RECOMMEND PCB LAYOUT
TOLERANCE: ± 0.05
TOP VIEW

 PCB AREA
 CONNECT AREA
 KEEP OUT AREA



MATERIALS

- HOUSING : THERMOPLASTIC (UL 94V-0).
- TERMINAL : COPPER ALLOY, PLATING SEE TABLE.
- SHELL : SUS
PLATING : NICKEL PLATED OVERALL.
GOLD PLATED ON SOLDER TAILS.

SPECIFICATION

- CURRENT RATING : 0.5 A. MAX.
- DIELECTRIC WITHSTANDING VOLTAGE :
500V AC R.M.S. FOR 1 MINUTE.
- INSULATION RESISTANCE : 1000MΩ MIN. AT 500V DC.
- CONTACT RESISTANCE : 30mΩ MAX.
- OPERATING TEMPERATURE : -40°C TO $+85^{\circ}\text{C}$.


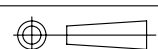
PART NUMBER INFORMATION :

5190106-X1002S-R

SERIES CODE
 SMT 180°
 SIM CARD
 SINGLE TYPE
 NUMBER OF POSITIONS

R:RoHS
 FOLLOW NUMBER
 W/O PUSH
 INSERT TYPE
 PLATING SEE TABLE

DESCRIPTION OF PLATING ON TERMINALS			
NO.	EXPLAIN	NO.	EXPLAIN
0	GOLD FLASH	3	GOLD 15u"
1	GOLD 5u"	4	GOLD 20u"
2	GOLD 10u"	6	G/F + TIN

TOLERANCE .0=±0.25 .00=±0.15 .000=±0.05 ANG.=±3°	DRAWER <i>JIN</i>	 ASTRON TECHNOLOGY CORP. NAME	
 UNITS : mm	CHECK <i>JANPE</i>		
SCALE NONE	SIZE A7	APP'D <i>ERP</i>	NAME MICRO SIM SOCKET 6PIN 1.30H
SHEET 1 OF 1	REV. B	PRODUCT SPEC. —	DRAW NO. R5190106-X1002S-R